

HD74LVC1G98

Configurable Multiple-Function Gate

REJ03D0013-0400Z Rev.4.00 Jun. 30, 2004

Description

The HD74LVC1G98 has configurable multiple—function gate in a 6-pin package. The Output state is determined by eight patterns of 3-bit input. The user can choose the logic functions AND, NAND, OR, NOR, INVERTER, Non—Inverted Buffer, Data Selector. Low voltage and high-speed operation is suitable for the battery powered products (e.g., notebook computers), and the low power consumption extends the battery life.

Features

• The basic gate function is lined up as Renesas uni logic series.

• Supply voltage range: 1.65 to 5.5 V Operating temperature range: -40 to +85°C

• All inputs V_{IH} (Max.) = 5.5 V (@V_{CC} = 0 V to 5.5 V) All outputs V_{O} (Max.) = 5.5 V (@V_{CC} = 0 V)

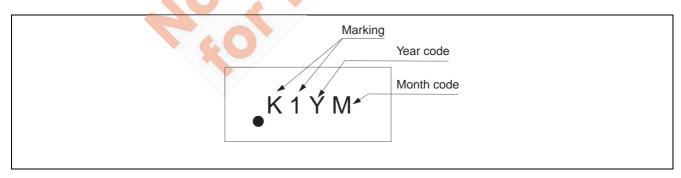
• Output current: $\pm 4 \text{ mA } (@V_{CC} = 1.65 \text{ V})$ $\pm 8 \text{ mA } (@V_{CC} = 2.3 \text{ V})$ $\pm 24 \text{ mA } (@V_{CC} = 3.0 \text{ V})$ $\pm 32 \text{ mA } (@V_{CC} = 4.5 \text{ V})$

• All the logical input has hysteresis voltage for the slow transition.

• Ordering Information

Part Name	Package Type	Package Code	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LVC1G98CPE	WCSP-6 pin	TBS-6V	CP	E (3,000 pcs/reel)
HD74LVC1G98CLE		TBS-6AV	CL	

Article Indication



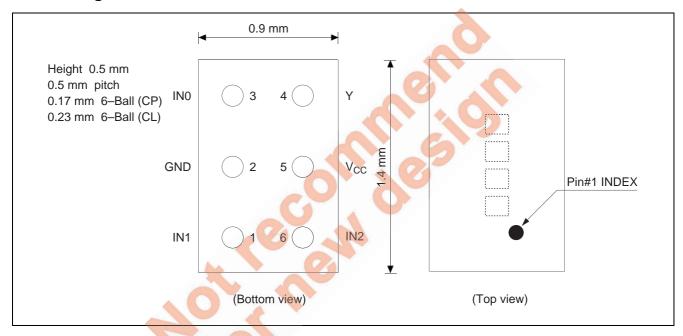
Function Table

	Output		
IN2	IN1	IN0	Υ
L	L	L	Н
L	L	Н	Н
L	Н	L	L
L	Н	Н	L
Н	L	L	Н
Н	L	Н	L
Н	Н	L	Н
Н	Н	Н	L

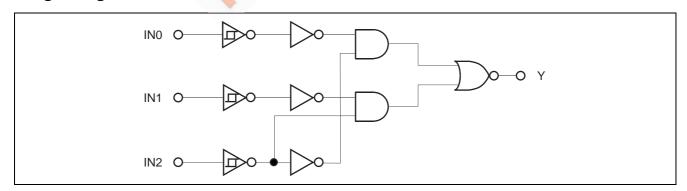
H: High level

L: Low level

Pin Arrangement



Logic Diagram

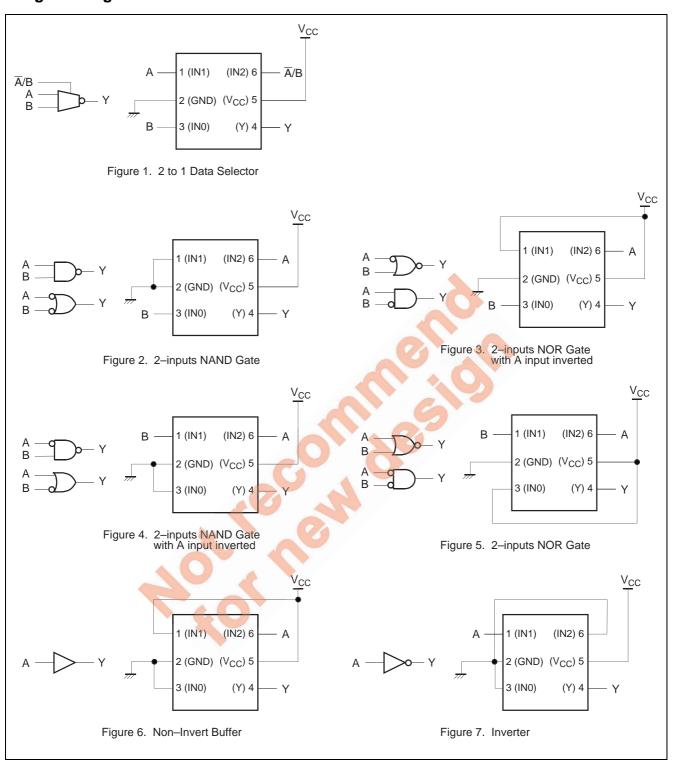


Function Selection Table

Logic Function	Figure No.
2 to 1 data Selector	1
2-inputs NAND	2
2-inputs NOR with one input inverted	3
2-inputs AND with one input inverted	3
2-inputs NAND with one input inverted	4
2-inputs OR with one input inverted	4
2-inputs NOR	5
Non-Invert Buffer	6
Inverter	7



Logic Configurations



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Test Conditions
Supply voltage range	V _{CC}	-0.5 to 6.5	V	
Input voltage range *1	Vı	-0.5 to 6.5	V	
Output voltage range *1, 2	Vo	-0.5 to V _{CC} + 0.5	V	Output : H or L
		-0.5 to 6.5		V _{CC} : OFF
Input clamp current	I _{IK}	-50	mA	V _I < 0
Output clamp current	I _{OK}	-50	mA	V _O < 0
Continuous output current	I _O	±50	mA	$V_O = 0$ to V_{CC}
Continuous current through V _{CC} or GND	I _{CC} or I _{GND}	±100	mA	
Package Thermal impedance	θ_{ja}	143	°C/W	СР
		123		CL
Storage temperature	Tstg	-65 to 150	°C	

Notes: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore no two of which may be realized at the same time.

- 1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- 2. This value is limited to 5.5 V maximum.

Recommended Operating Conditions

Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	Vcc	1.65	5.5	V	
Input voltage range	Vı	0	5.5	V	
Output voltage range	Vo	0	Vcc	V	
Output current	I _{OL}	_0	4	mA	$V_{CC} = 1.65 \text{ V}$
			8		$V_{CC} = 2.3 \text{ V}$
		- \	16		$V_{CC} = 3.0 \text{ V}$
	40		24		
		-	32		$V_{CC} = 4.5 \text{ V}$
	I _{OH}		-4		$V_{CC} = 1.65 \text{ V}$
			-8		$V_{CC} = 2.3 \text{ V}$
			-16		$V_{CC} = 3.0 \text{ V}$
		_	-24		
	60		-32		$V_{CC} = 4.5 \text{ V}$
Input transition rise or fall rate	Δt / Δν	0	20	ns / V	$V_{CC} = 1.65 \text{ to } 1.95 \text{ V},$
					2.3 to 2.7 V
		0	10	_	$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$
		0	5		$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$
Operating free-air temperature	Ta	-40	85	°C	

Note: Unused or floating inputs must be held high or low.

Electrical Characteristics

 $Ta = -40 \text{ to } 85^{\circ}\text{C}$

Item	Symbol	V _{CC} (V)	Min	Тур	Max	Unit	Test condition
Threshold voltage	V_T^+	1.8	0.8	_	1.4	V	
		2.5	1.2	_	1.7		
		3.3	1.6	_	2.3		
		5.0	2.3	_	3.0		
	V _T	1.8	0.4	_	0.7		
		2.5	0.6	_	1.0		
		3.3	0.9	_	1.4		
		5.0	1.5	_	2.0		
	ΔV_T	1.8	0.4	_	0.7		
		2.5	0.4	_	0.8	<u></u>	
		3.3	0.4	_	0.9	<u></u>	
		5.0	0.4	_	1.0		
Output voltage	V_{OH}	1.65 to 5.5	V _{CC} -0.1		_	V	$I_{OH} = -100 \mu A$
		1.65	1.2		_		$I_{OH} = -4 \text{ mA}$
		2.3	1.9	_			$I_{OH} = -8 \text{ mA}$
		3.0	2.4	_	-		$I_{OH} = -16 \text{ mA}$
			2.3			A	$I_{OH} = -24 \text{ mA}$
		4.5	3.8				$I_{OH} = -32 \text{ mA}$
	V_{OL}	1.65 to 5.5	_	-	0.1		$I_{OL} = 100 \mu A$
		1.65		-	0.45		$I_{OL} = 4 \text{ mA}$
		2.3			0.3	<u></u>	$I_{OL} = 8 \text{ mA}$
		3.0	-	-	0.4		$I_{OL} = 16 \text{ mA}$
					0.55		$I_{OL} = 24 \text{ mA}$
		4.5		. –	0.55		$I_{OL} = 32 \text{ mA}$
Input current	I _{IN}	0 to 5.5		_	±5	μΑ	$V_{IN} = 5.5 \text{ V or GND}$
Quiescent	Icc	5.5	- 1		10	μΑ	$V_{IN} = V_{CC}$ or GND,
supply current							I _O = 0
	Δ lcc	3 to 5.5	AU	_	500		One input at V _{CC} -0.6 V,
	1						Other input at V _{CC} or GND
Output leakage current	loff	0		_	±10	μΑ	V_{IN} or $V_O = 0$ to 5.5 V
Input capacitance	C _{IN}	3.3	_	3.5	_	pF	$V_{IN} = V_{CC}$ or GND

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

Switching Characteristics

 $V_{CC}=1.8{\pm}0.15~V$

		Ta = -40	to 85°C			FROM	ТО
Item	Symbol	Min	Max	Unit	Test Conditions	(Input)	(Output)
Propagation delay time	t _{PLH} t _{PHL}	3.2	14.4		$C_L = 30 \text{ pF},$ $R_L = 1.0 \text{ k}\Omega$	IN	Y

 $V_{CC}=2.5{\pm}0.2~V$

		Ta = -40) to 85°C			FROM	ТО
Item	Symbol	Min	Max	Unit	Test Conditions	(Input)	(Output)
	t _{PLH} t _{PHL}	2.0	8.3		$C_L = 30 \text{ pF},$ $R_L = 500 \Omega$	IN	Y

 $V_{CC} = 3.3 \pm 0.3 \text{ V}$

		Ta = -40) to 85°C			FROM	ТО
Item	Symbol	Min	Max	Unit	Test Conditions	(Input)	(Output)
1 ' 0	t _{PLH} t _{PHL}	1.5	6.3		$C_L = 50 \text{ pF},$ $R_L = 500 \Omega$	IN	Υ

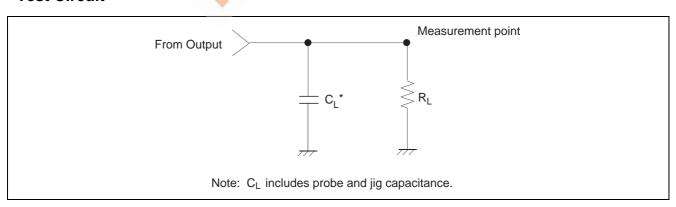
 $V_{CC} = 5.0 \pm 0.5 \text{ V}$

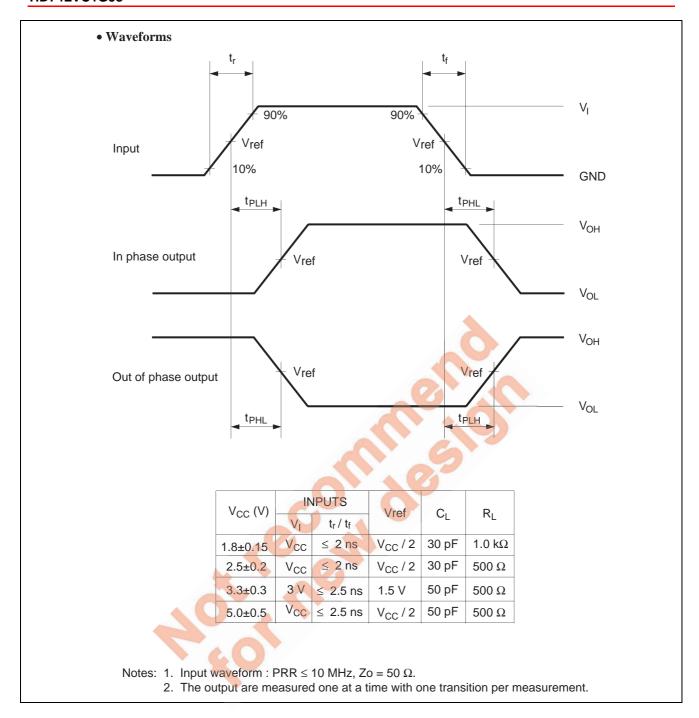
		Ta = -40) to 85°C			* OV	FROM	ТО
Item	Symbol	Min	Max		Unit	Test Conditions	(Input)	(Output)
	t _{PLH} t _{PHL}	1.1	5.1	ns		$C_L = 50 \text{ pF},$ $R_L = 500 \Omega$	IN	Y

Operating Characteristics

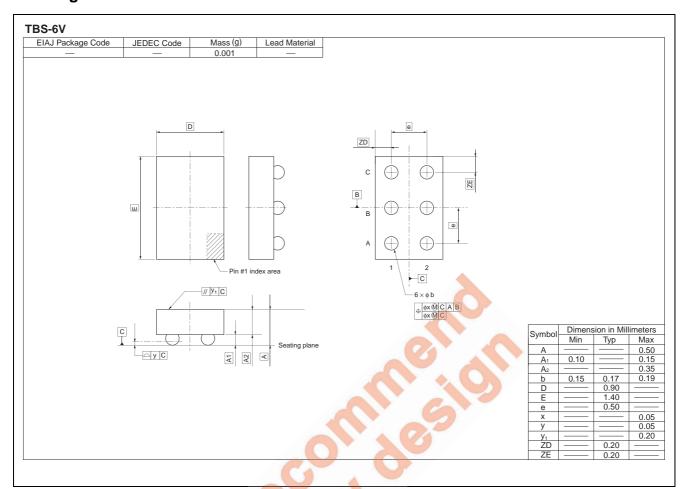
			13	Ta = 25°C			
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Unit	Test Conditions
Power dissipation capacitance	C _{PD}	1.8		23	_	pF	f = 10 MHz
	20	2.5	-	23	_		
	9 0	3.3	_	23	_		
		5.0		26	_		

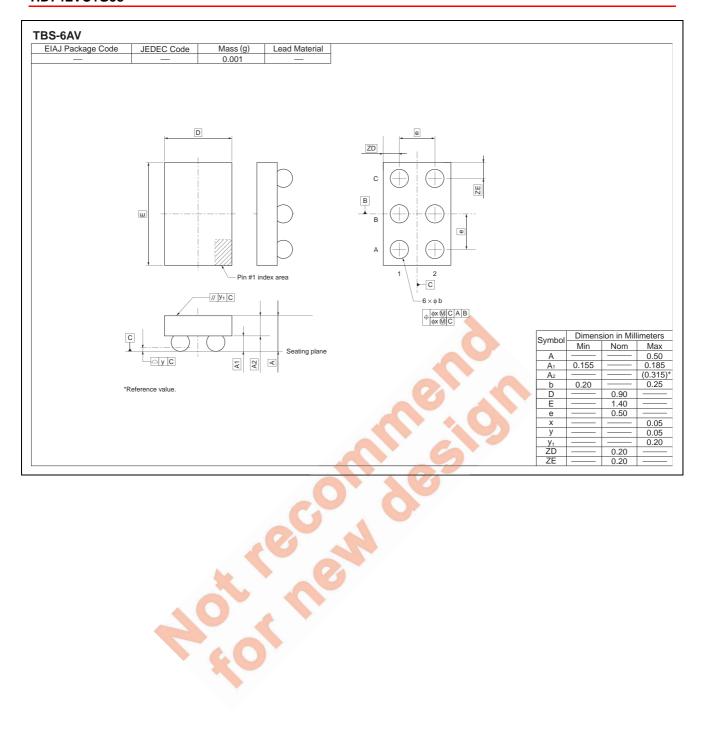
Test Circuit





Package Dimensions





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Renesas Technology Singapore Pte. Ltd.
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